1975/25	
Form PTO-1595 (Rev. 6-93)	
Tab settings ⇒ ⇒ ⇒	
To the Honorable Commissioner Pate 10306	
1. Name of conveying party(ies):	Name and address of receiving party(ies)
YEHUSHUA YESHURUN, MEIR HEFETZ, MEINT DE BOER, J.W. BERENSCHOT, J.G.E. GARDENIERS Additional name(s) of conveying party(ies) attached? Yes No	Name: Nanopass Technologies Ltd. Internal Address:
3. Nature of conveyance:	
Assignment Merger	Street Address: 18 Haneviim St.
Security Agreement Change of Name	Haifa 31043, Israel
	City: State: ZIP:
Execution Date: 2 May 2005	Additional name(s) & address(es) attached?
A. Patent Application No.(s) 10/362,835 Additional numbers attached? Yes No	
Name and address of party to whom correspondence concerning document should be mailed:	6. Total Number of applications and patents involved:
Name: Mark M. Friedman	7. Total fee (37 CFR 3.41)\$ <u>40</u>
Internal Address:	Enclosed
	Authorized to be charged to deposit account
Street Address: c/o Bill Polkinghorn	8. Deposit account number:
Discovery Dispatch, Florin Way 9003	06-2140
City: <u>Upper Marlboro</u> State: <u>MD</u> ZIP: <u>20772</u>	
725/2005 F000PR 00000116 062140 10362835 DO NOT USE T	(Attach duplicate copy of this page if paying be deposit account)
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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
Mark M. Friedman Name of Person Signing Signa	Ure Date
Total number of pages including cover sheet, attachments, and document:	

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231 8. MAY. 2005 8:41

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the undersigned:

Yehoshua Yeshurun

Meir Hefetz Meint De Boer

J.W. Berenschot

J.G.E. Gardeniers

NO. 434

(hereinafter called the "assignor(s)"), hereby sell(s), assign(s) and transfer(s) to:

Nanopass Technologies Ltd.

(hereinafter called the "assignee(s)"), its/his successors, assignees, nominees or other legal representatives, the assignor's entire right, title and interest in and to the invention entitled:

MICRONEEDLE STRUCTURE AND PRODUCTION METHOD THEREFOR

described and claimed in the following patent applications:

U.S. Patent Application No. 10/362,835 (Attorney docket No. 1975/25);

and in and to said Patent Applications, and all original and reissued Patents granted therefor, and all divisions and continuations thereof, including the right to apply and obtain Patents in all other countries, the priority rights under International Conventions, and the Letters Patent which may be granted thereon.

Signed and sealed this _____ day of ________2005

Meir Hefetz

Meint De Boer

J.W. Berenschot

105 Cordence

RECORDED: 08/23/2005

PATENT REEL: 016909 FRAME: 0376